



Operation:0.80MM PITCH MINI-PCI EXPRESS / [MINI-PCI E 连接器]

REACH

RoHS Compliant

LTEM NO.:PCIE-52P□□H

(L29.9mm×W8.2mm /52 CIRCUITS WITH FITTING NAILS)

Technical parameter

LEVEL		A[better product]	
PROJECT			
Electrical Properties	Contact Rating	0.5A Per PIN / 50V DC	
	Initial Contact Resistance	50mΩ min.	50mΩ max.
	Insulation Resistance	500MΩ min.	
	Withstand Voltage	300V AC for 1 minute	300 V AC for 1 minut
	There No Load	200 Cycle	
Durable Performance	Rated Load	100 Cycle	
	Storage temp.	-40℃～+85℃(Operating Temp:)	

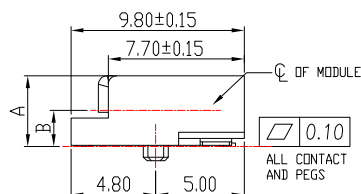
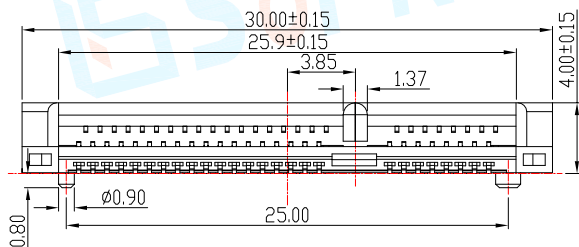
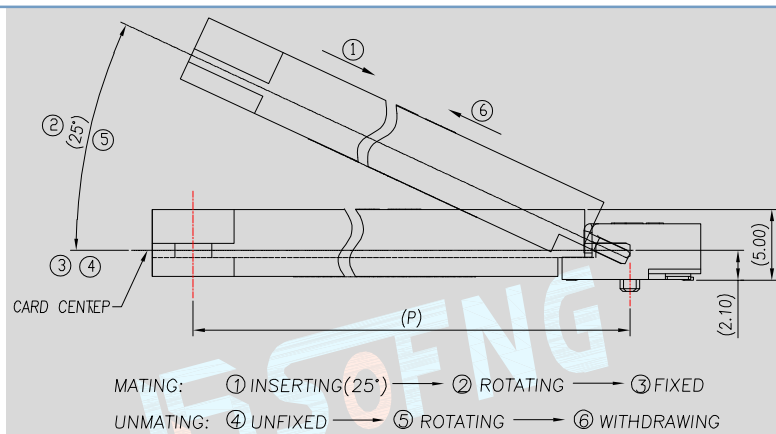
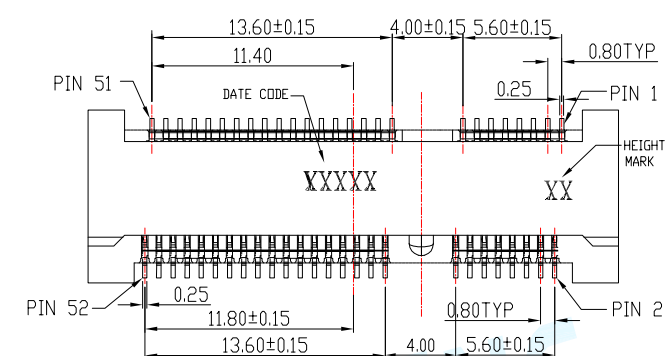
側向導入 LATERAL

精密部品 NICETY

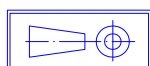
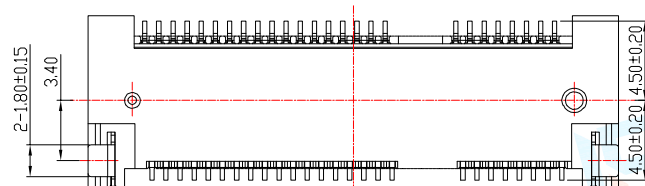
可靠 STABILIZE

適合環保 RoHS

Unit:mm



LTEM NO	DIM A	DIM B
PCIE-52P40H	4.0mm	2.05 mm
PCIE-52P52H	5.2mm	3.25 mm
PCIE-52P56H	5.6mm	3.65 mm
PCIE-52P70H	7.0mm	5.05 mm
PCIE-52P80H	8.0mm	6.05 mm
PCIE-52P90H	9.0mm	7.05 mm
PCIE-52P99H	9.9mm	7.95 mm



Material declaration

No.	NAME	MATERIAL	DESCRIPTION
① A	HOUSING 基座	THERMOPLASTIC LCP MG305	UL 94V-0,COLOR:BLACK;
② B	TERMINAL 接触端子	COPPER ALLOY [G/F] 磷铜合金 C5210	2.0 μm Ni PLATED OVERALL; 0.25 μm Au PLATED CONTACT AREA; GOLD FLASH ON SOLDER AREA.
③ C	HOLDDOWN 固定端子	COPPER ALLOY 黄铜 C2680	0.25 μm Ni PLATED OVERALL;

Operating Force

Inward
Exiting

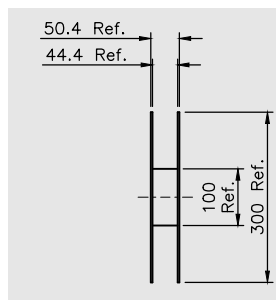
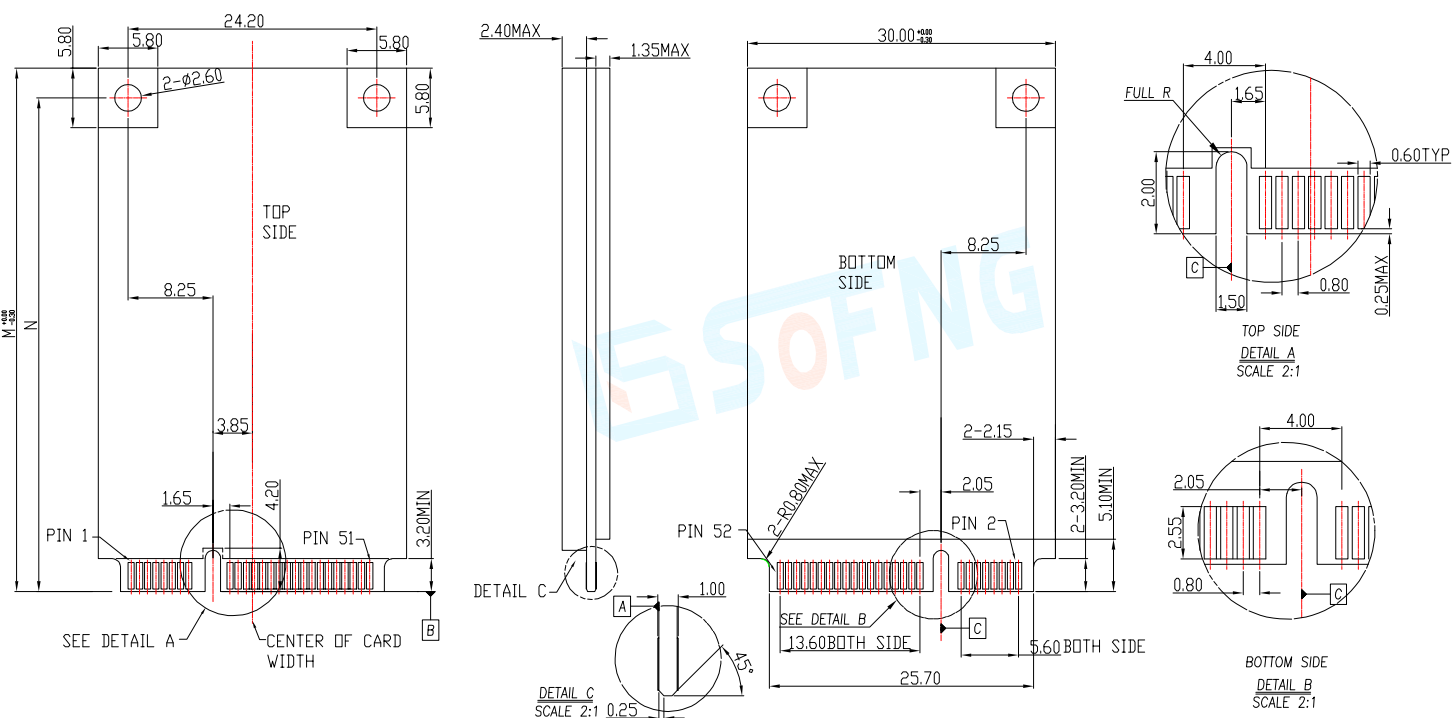
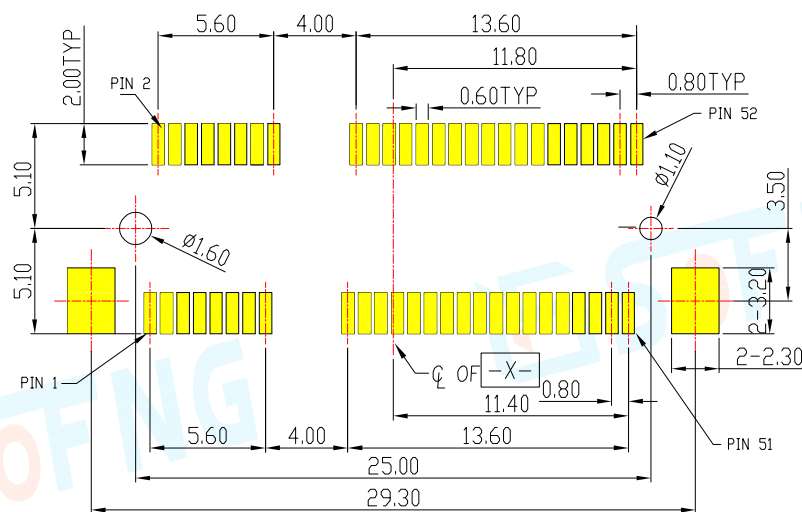
2. 3Kgf MAX.

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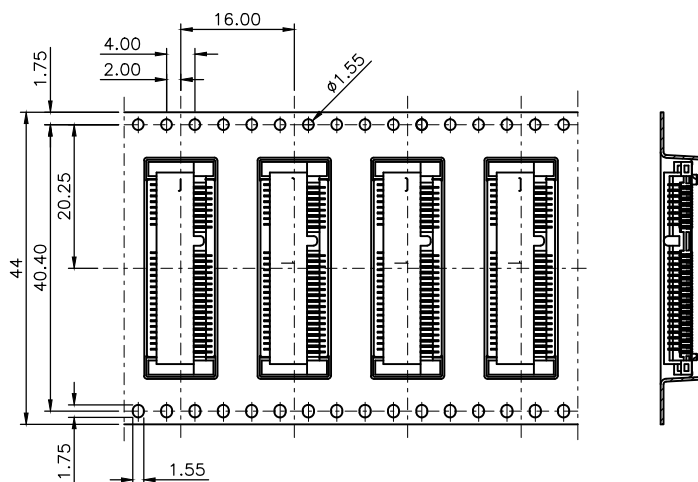
Solder-ability (Max.)

IR Reflow: 255°C, 5sec.

Manual I : 350°C, 3sec.



PACKING TABLE	
P/N	Q'TY/REEL
PCIE-52P40H	650PCS
PCIE-52P52H	550PCS
PCIE-52P56H	500PCS
PCIE-52P70H	400PCS
PCIE-52P80H	400PCS



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